PATENT ASSIGNMENT

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SUBMISSION TYPE:			NEW ASSIGNMENT			
NATURE OF CONVEYANCE:			NUNC PRO TUNC ASSIGNMENT			
EFFECTIVE DATE:			04/09/2013			
CONVEYING PARTY DATA						
N			ame	Execution Date		
SAE Magnetics (H.K.) Ltd.				08/22/2013		
RECEIVING PARTY DATA						
Name:	SAE Magnetics (H.K.) Ltd.					
Street Address:	SAE Technology Centre, 6 Science Park East Avenue, Hong Kong Science Park, Shatin, N.T.					
City:	Hong Kong					
State/Country:	CHINA					
Name:	TDK Corporation					
Street Address:	TDK Corporation 1-13-1, Nihonbashi, Chuo-Ku					
City:	Токуо					
State/Country:	JAPAN					
Postal Code:	103-8272					
PROPERTY NUMBERS Total: 1						
Property Type						
		137242	4283			
CORRESPONDENCE DATA						
Fax Number: 7038164100						
Correspondence will be sent via US Mail when the fax attempt is unsuccessful.						
Phone: 7038164000						
Email:	mg@nixonvan.com					
Correspondent Name						
Address Line 1:						
Address Line 2: Address Line 4:	11TH FLOOR ARLINGTON, VIRGINIA 22203					
502469100			REEL:	PATENT 031068 FRAME: 0097		

ATTORNEY DOCKET NUMBER:	9908-42			
NAME OF SUBMITTER:	Joseph S. Presta			
Signature:	/Joseph S. Presta/			
Date:	08/23/2013			
Total Attachments: 2 source=P807US-NUNC-PRO-TUNC PATENT ASSIGNMENT#page1.tif source=P807US-NUNC-PRO-TUNC PATENT ASSIGNMENT#page2.tif				

NUNC-PRO-TUNC PATENT ASSIGNMENT

WHEREAS, SAE Magnetics (H.K.) Ltd., (hereinafter ASSIGNOR), a corporation doing business at SAE Technology Centre, 6 Science Park East Avenue, Hong Kong Science Park, Shatin, N.T., Hong Kong, People's Republic of China and having been assigned all right, title and interest in and to U.S. Application 13/724,283 filed December 21, 2012 naming Yasutoshi FUJITA, Ryuji FUJII, Hideki TANZAWA, Natsuo NISHIJIMA, Tai Boon LEE, Jian Hui HUANG, Huan Chao LIANG, Koji SHIMAZAWA, Kei HIRATA, and Daisuke MIYAUCHI (hereinafter INVENTORS) as inventors and titled THERMALLY ASSISTED MAGNETIC HEAD SLIDER, HEAD GIMBAL ASSEMBLY, AND HARD DISK DRIVE WITH THE SAME, AND MANUFACTURING METHOD THEREOF by assignment from the inventors recorded April 9, 2013 in the U.S. Patent and Trademark Office at Reel 030178, Frame 0729;

WHEREAS, ASSIGNOR hereby confirms that ASSIGNOR has the full right to convey all rights, as herein expressed, to the said application and the inventions embodied therein, including all continuing, division, and reissue applications and the inventions embodied therein;

AND WHEREAS, TDK Corporation (hereinafter ASSIGNEE), a corporation doing business at TDK Corporation 1-13-1, Nihonbashi, Chuo-Ku, Tokyo, 103-8272, JAPAN, is desirous of acquiring the right, title and interest that ASSIGNEE would have had if the inventors had originally named both ASSIGNEE and ASSIGNOR as assignees in the assignment recorded April 9, 2013 in the U.S. Patent and Trademark Office at Reel 030178, Frame 0729;

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NOW, THEREFORE, in consideration of Ten Dollars (\$10.00) and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the said ASSIGNOR by these presents hereby sells, assigns, and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, <u>nunc-pro-tunc</u> as of the inventors' original assignment executed by INVENTORS on January 9, 2013, January 7, 2013, January 8, 2013, January 7, 2013, January 8, 2013, January 7, 2013, respectively, the entire right, title and interest that ASSIGNEE would have had if the inventors had originally named both ASSIGNEE and ASSIGNOR as assignees in the assignment recorded April 9, 2013 in the U.S. Patent and Trademark Office at Reel 030178, Frame 0729.

Executed this \overrightarrow{a} day of \overrightarrow{b} , 2013.

SAE Magnetics (H.K.) Ltd.

Ву:

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